

Title (en)
COPPER ALLOY

Title (de)
KUPFERLEGIERUNG

Title (fr)
ALLIAGE DE CUIVRE

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Application
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Abstract (en)
[origin: WO2012062248A2] The invention relates to alloys based on copper, which comprise additives of manganese and sulfur and/or calcium and tramp elements. The copper alloys are free of tellurium and lead and are characterized by high electrical conductivity and good machinability.

IPC 8 full level
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